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Electronic Patent Application Submission
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EFS ID: 64280

Application ID: 10766046



Title of Invention: LEADFRAME TYPE
SEMICONDUCTOR PACKAGE
HAVING REDUCED INDUCTANCE
AND ITS MANUFACTURING
METHOD

First Named Inventor: GI KIM

Domestic/Foreign Application: Domestic Application

Filing Date: 2004-01-28

Effective Receipt Date: 2004-07-09

Submission Type: Information Disclosure
Statement

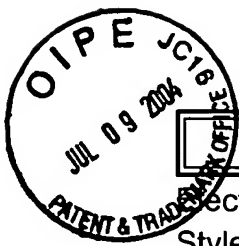
Filing Type:

Confirmation number: 2288

Attorney Docket Number: AMKOR099


Total Fees Authorized:

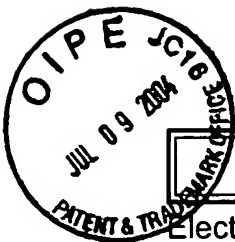
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TRANSMITTAL

Electronic Version v1.1
Stylesheet Version v1.1.0

Title of Invention	LEADFRAME TYPE SEMICONDUCTOR PACKAGE HAVING REDUCED INDUCTANCE AND ITS MANUFACTURING METHOD									
<p>Application Number: 10/766046 </p> <p>Date: 2004-01-28</p> <p>First Named Applicant: GI JEONG KIM</p> <p>Confirmation Number: 2288</p> <p>Attorney Docket Number: AMKOR099</p>										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>MARK B. GARRED Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney		
Submitted by:	Elec. Sign.	Sign. Capacity								
MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney								
<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>ids6-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	ids6-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
us-ids	ids6-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of
Invention

LEADFRAME TYPE SEMICONDUCTOR PACKAGE HAVING REDUCED INDUCTANCE AND ITS MANUFACTURING METHOD

Application Number: 10/766046



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First Named Applicant: GI KIM

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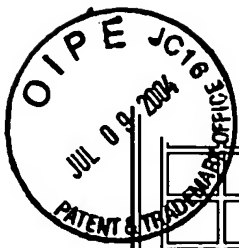
Art Unit: 2613

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or 6420779 or 6429508 or 6437429 or 6444499
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or 6498392 or 6507096 or 6507120 or 6534849
or 6545332 or 6545345 or 6559525 or 6566168
or 6583503 or 6603196 or 6667546 or
6624005).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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	2	6355502	2002-03-12	Kang et al.			
	3	6369447	2002-04-09	Mori			
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<input type="checkbox"/>	21	6476469	2002-11-05	Huang et al.
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<input type="checkbox"/>	35	6667546	2003-12-23	Huang et al.
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Signature

Examiner Name	Date